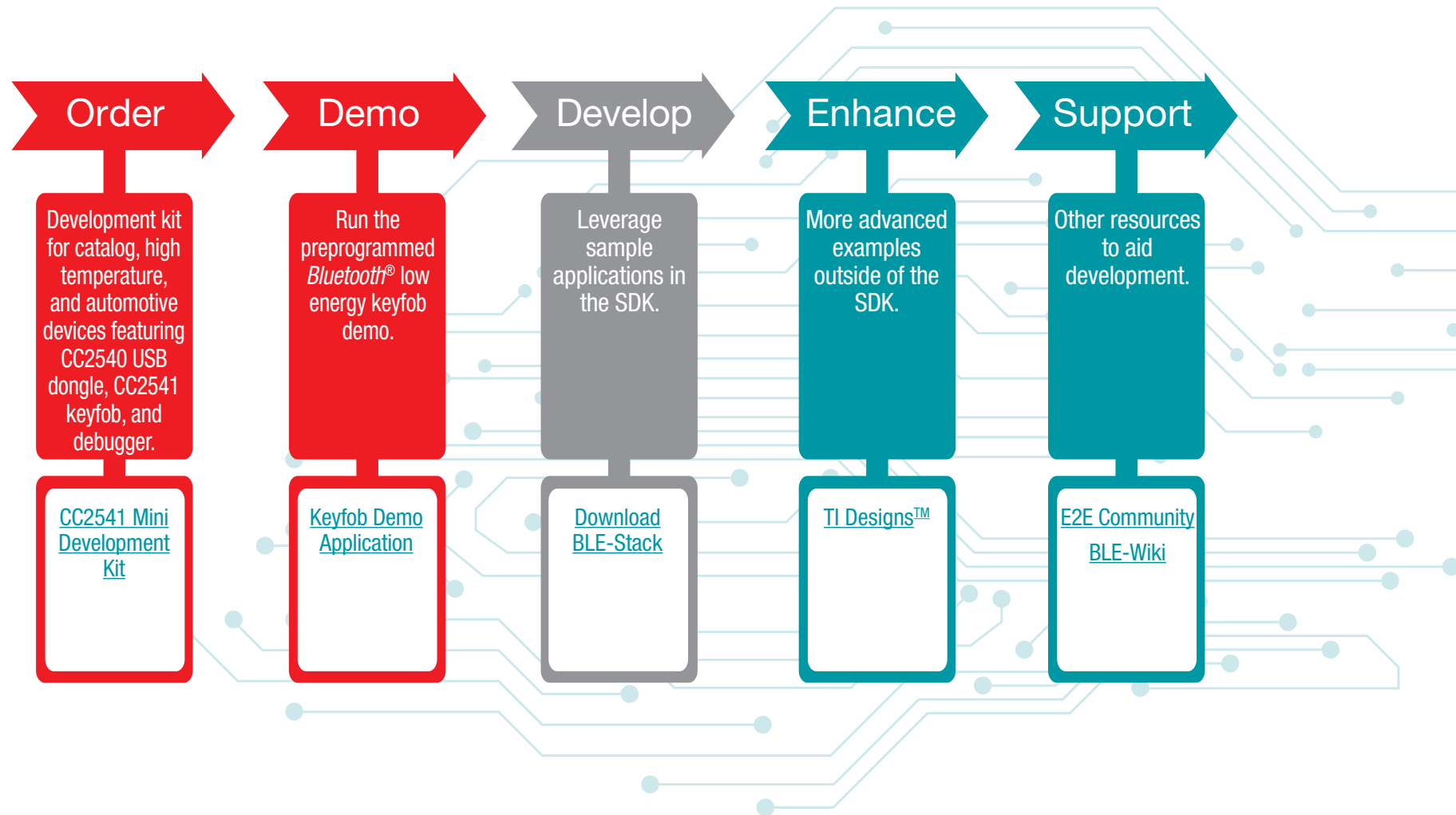


Getting started with *Bluetooth*[®] low energy CC2541, CC2541-Q1, CC2540, & CC2540T for IAR users

Proven and robust, *Bluetooth*[®] 4.0 compliant



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